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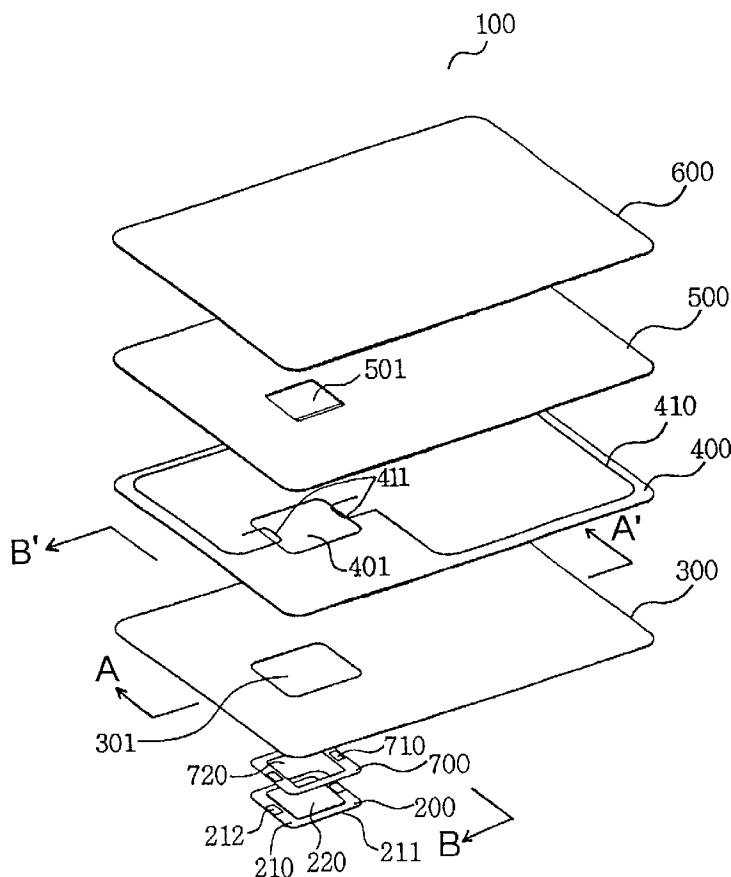
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[Continued on next page]

- (54) Title:** METHOD FOR MANUFACTURING IC CARD BY LAMINATING A PLURALITY OF FOILS



(57) Abstract: The present invention provides a method for manufacturing IC card by laminating a plurality of foils. The method of the present invention includes steps of putting a COB, a contact electrode of the COB facing downward; laying at least 2 foils having a hole, wherein said COB is inserted in said respective holes of the foils; laying a foil not having a hole on the foils having a hole; and compressing all of the foils.



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